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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Todd O. Bolken

Serial No.: 09/516,080

Filed: March 1, 2000

For: EXPOSED DIE MOLDING  
APPARATUS

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Group Art Unit: 2814

Examiner: Louie, Wai Sing

Atty Docket: MICS:0043 FLE/MAN  
99-0634

#13/Response  
marsha  
2/14/03

Assistant Commissioner  
for Patents  
Washington, D.C. 20231

CERTIFICATE OF MAILING 37 C.F.R. 1.8	
I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on the date below:	
February 5, 2003 Date	 Robert A. Manware

Sir:

**RESPONSE**

In response to the Official Action mailed on November 5, 2002, Applicant respectfully requests reconsideration of the above-identified application in view of the remarks set forth below.

RECEIVED  
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